# **Specification of Thermoelectric Module**

TEFC1-00809

### **Description**

The 8 couples,  $3.8/3.2 \text{ mm} \times 3.2 \text{mm}$  size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 74 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

#### **Features**

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

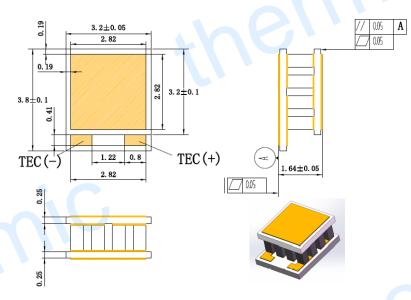
## **Application**

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

### **Performance Specification Sheet**

Th ( °C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>
DT <sub>max</sub> (°C)	74	83	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U <sub>max</sub> (Voltage)	1.06	1.15	Voltage applied to the module at DT <sub>max</sub>
I <sub>max</sub> (Amps)	0.9	0.9	DC current through the modules at DT <sub>max</sub>
Q <sub>Cmax</sub> (Watts)	0.59	0.64	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	0.89	0.96	The module resistance is tested under AC
Tolerance (%)	10%		For thermal and electricity parameters

### Geometric Characteristics Dimensions in millimeters



## **Manufacturing Options**

#### A. Solder:

T100: BiSn (Tmelt=138 ℃)

T200: CuSn (Tmelt=227 °C)

**B. Sealant:** 

NS: No sealing

C. Ceramics:

Aluminum Nitride (AlN)

D. Ceramics Surface Options:

Hot side: Metalized (Au plating)
Cold side: Metalized (Au plating)

## **Ordering Option**

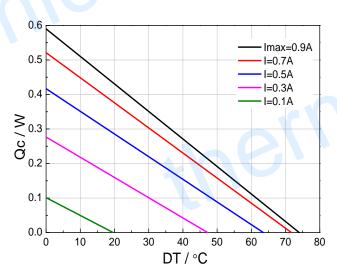
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	$0:1.64\pm0.05$	0: 0.05/0.05	No Wires

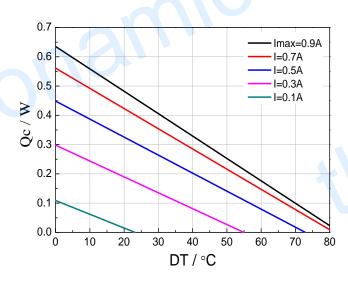
# **Specification of Thermoelectric Module**

## **TEFC1-00809**

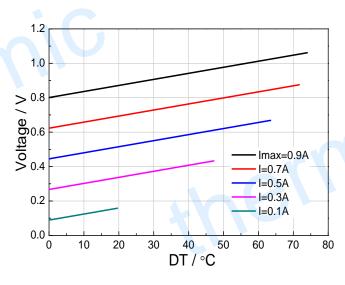
### Performance Curves at Th=27 ℃

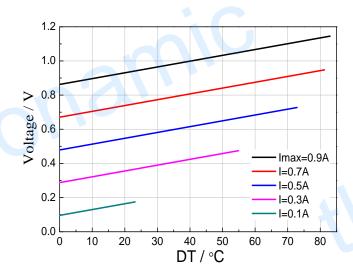
### Performance Curves at Th=50 ℃



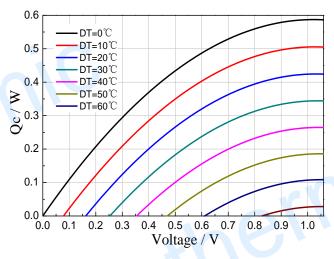


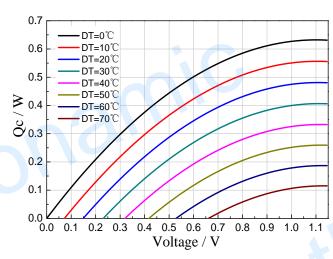
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V= f(DT)



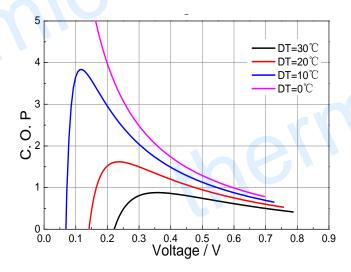


Standard Performance Graph Qc = f(V)

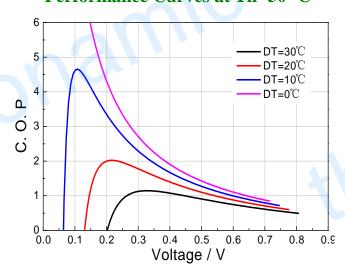
# **Specification of Thermoelectric Module**

### **TEFC1-00809**

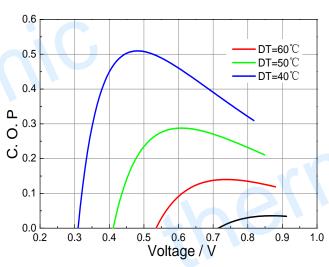
### **Performance Curves at Th=27 ℃**

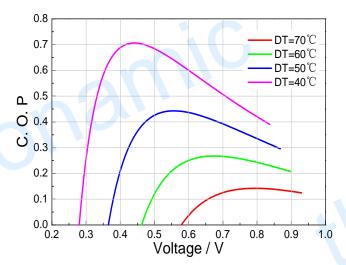


### Performance Curves at Th=50 ℃



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

**Remark:** The coefficient of performance (COP) is the cooling power Qc/Input power (V  $\times$  I).

## **Operation Caution**

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- $\bullet$  Operation below  $I_{\text{max}}$  or  $V_{\text{max}}$
- Work under DC

Note: All specifications subject to change without notice.